

**Type of Notification:**

**Extension Of PTC Assembly Location**

Issue Date	Notification No.
17 February 2006	TEPC2005-029

**Description:**

This is to notify you that Raychem Circuit Protection will be extending it's downstream manufacturing capabilities for the surface mount polymeric PTC devices to Shanghai, PRC. The downstream manufacturing process includes:

- Singulation of devices from panelized form
- Device inspection
- Quality control
- Resistance measurement
- Packaging

The upstream and midstream processes, namely to process the devices to a panelized form, will remain in the USA.

By institution of this extension, the Specification Control Document will remain unchanged and will not be affected. This change will also not affect the electrical specification or the form, fit and function of the devices.

**Products Affected:**

microSMD005-2	microSMD035-2	microSMD075-2	microSMD150-2
microSMD005F -2	microSMD035F-2	microSMD075F-2	microSMD150F-2
microSMD010-2	microSMD050-2	microSMD110-2	microSMD175F-2
microSMD010F-2	microSMD050F-2	microSMD110F-2	

**Additional Information**

Test data of downstream process in Shanghai, PRC and Menlo Park, CA, USA demonstrates equality of devices with both sites using the same manufacturing batch numbers. Test data is available upon request.

The extension of the downstream process to Shanghai, PRC allows us to provide our customers surface mount polymeric PTC Devices from both USA and PRC assembly locations. Raychem will reserve the rights to supply their customers from either location.

Raychem Circuit Protection intends to ship above listed Shanghai, PRC assembled parts starting April 1<sup>st</sup>, 2006. Should you need additional approval, please notify us within the next 14 business days from the date of this letter.

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